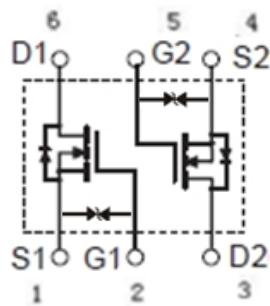


Features

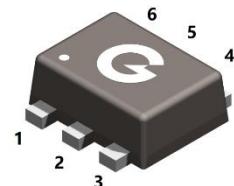
- Low on-resistance
- High-speed switching
- Drive circuits can be simple
- Parallel use is easy
- JEDEC22-A114-B: 2

HF



Typical Applications

- N-channel enhancement mode effect transistor
- Switching application



SOT-563

Mechanical Data

- Case: SOT-563
- Molding Compound: UL Flammability Classification Rating 94V-0
- Terminals: Matte tin-plated leads; solderability-per MIL-STD-202, Method 208

Ordering Information

Part Number	Package	Shipping Quantity	Marking Code
2N5003V	SOT-563	3000 pcs / Tape & Reel	53

Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V_{DSS}	50	V
Gate-to-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current ^{*1}	I_D	300	mA
Pulsed Drain Current ($t_p = 10\mu\text{s}$)	I_{DM}	2000	mA
Power Dissipation ($T_A = 25^\circ\text{C}$) ^{*1}	P_D	0.25	W
Operating Junction Temperature Range	T_J	-55 ~ +150	°C
Storage Temperature Range	T_{STG}	-55 ~ +150	°C

Thermal Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal Resistance Junction-to-Air ^{*1}	$R_{\theta JA}$	-	-	500	°C/W

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	MIN	TYP	MAX	UNIT
OFF Characteristics						
V_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	50	-	-	V
$I_{DS(on)}$	Drain to Source Leakage Current	$V_{DS} = 50\text{V}, V_{GS} = 0\text{V}$	-	-	1	μA
I_{GSS}	Gate-body Leakage	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	-	-	± 10	μA
ON Characteristics						
$R_{DS(on)}$	Drain-Source On-resistance ^{*2}	$V_{GS} = 10\text{V}, I_D = 0.5\text{A}$	-	1.1	1.5	Ω
		$V_{GS} = 4.5\text{V}, I_D = 0.2\text{A}$	-	1.2	2.5	
		$V_{GS} = 2.5\text{V}, I_D = 0.2\text{A}$	-	1.6	2.9	
		$V_{GS} = 1.8\text{V}, I_D = 0.05\text{A}$	-	2.8	4.0	
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	0.5	0.8	1.0	V
R_G	Gate Resistance	$V_{GS} = 0\text{V}, f = 1\text{MHz}$	-	34	-	Ω
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 20\text{V}$ $f = 1.0\text{MHz}$	-	44	-	pF
C_{oss}	Output Capacitance		-	10	-	
C_{rss}	Reverse Transfer Capacitance		-	7	-	
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time ^{*3}	$V_{DD} = 30\text{V}, I_D = 0.2\text{A}$ $V_{GS} = 10\text{V}, R_G = 25\Omega$ $R_L = 150\Omega$	-	6	-	nS
t_r	Turn-on Rise Time ^{*3}		-	5	-	
$t_{d(off)}$	Turn-Off Delay Time ^{*3}		-	25	-	
t_f	Turn-Off Fall Time ^{*3}		-	15	-	
Q_G	Total Gate-Charge	$V_{DD} = 25\text{V}$ $V_{GS} = 10\text{V}$ $I_D = 0.2\text{A}$	-	4.3	-	nC
Q_{GS}	Gate to Source Charge		-	0.7	-	
Q_{GD}	Gate to Drain (Miller) Charge		-	0.5	-	
Source-Drain Diode Characteristics						
V_{SD}	Diode Forward Voltage ^{*2}	$I_S = 0.3\text{A}, V_{GS} = 0\text{V}$	-	0.85	1.2	V

Notes:

1. The data tested by surface mounted on a FR-4 board
2. The data tested by pulsed, pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
3. Guaranteed by design, not subject to production

Ratings and Characteristics Curves (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

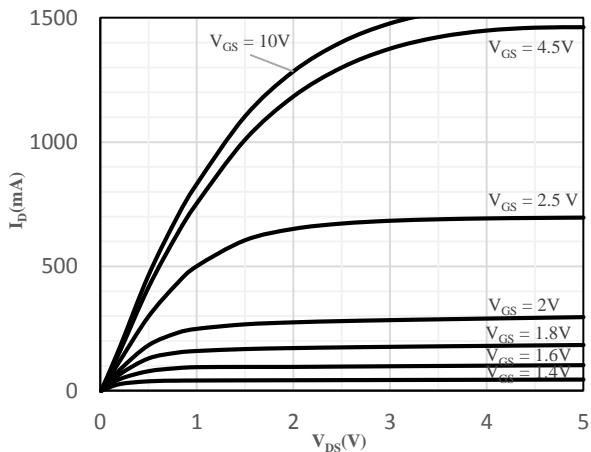


Fig 1 Typical Output Characteristics

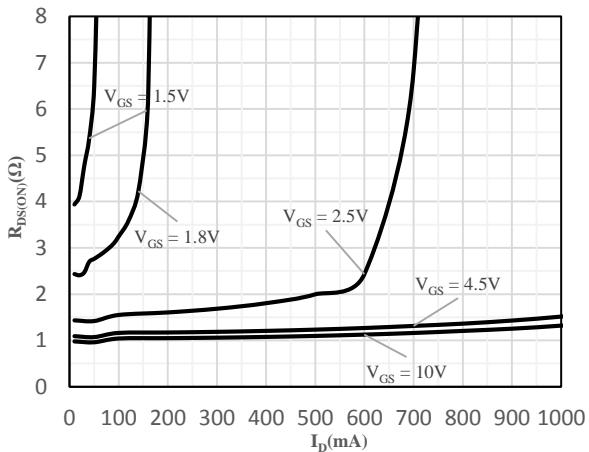


Fig 2 On-Resistance vs. Drain Current and Gate Voltage

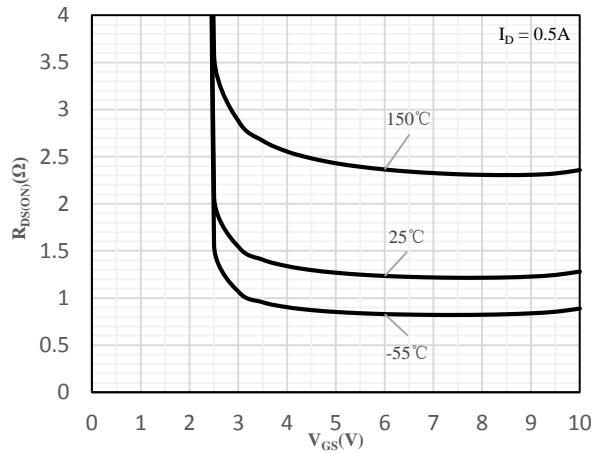


Fig 3 On-Resistance vs. Gate-Source Voltage

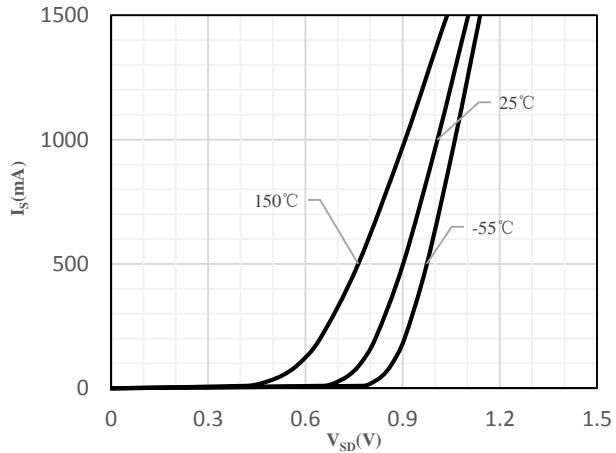


Fig 4 Body-Diode Characteristics

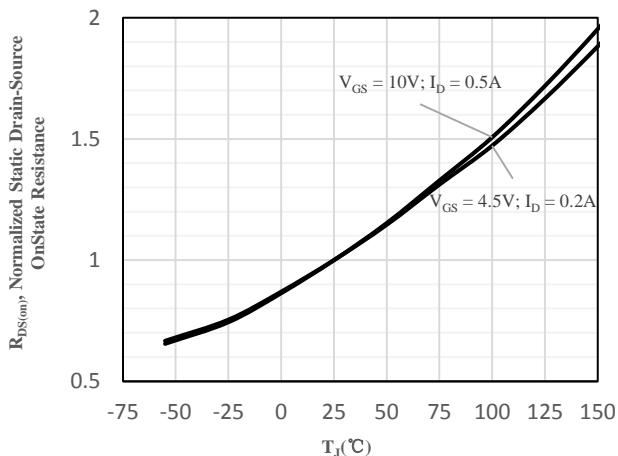


Fig 5 Normalized On-Resistance vs. Junction Temperature

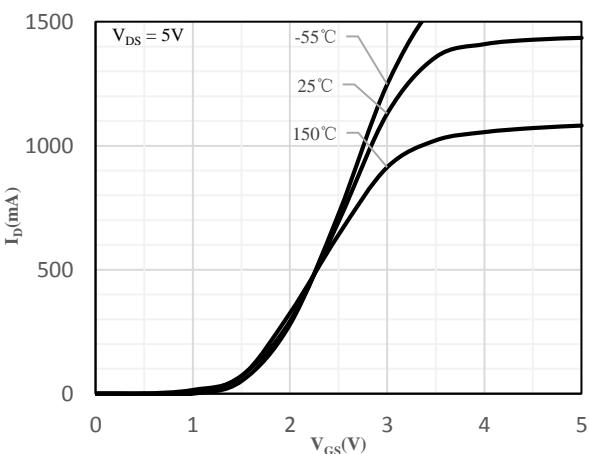


Fig 6 Transfer Characteristics

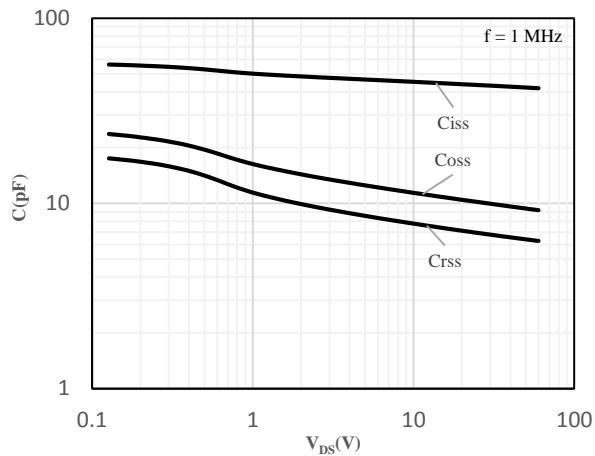


Fig 7 Capacitance Characteristics

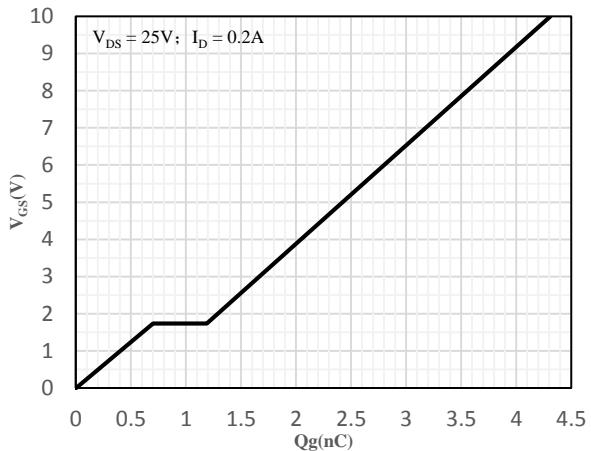


Fig 8 Gate-Charge Characteristics

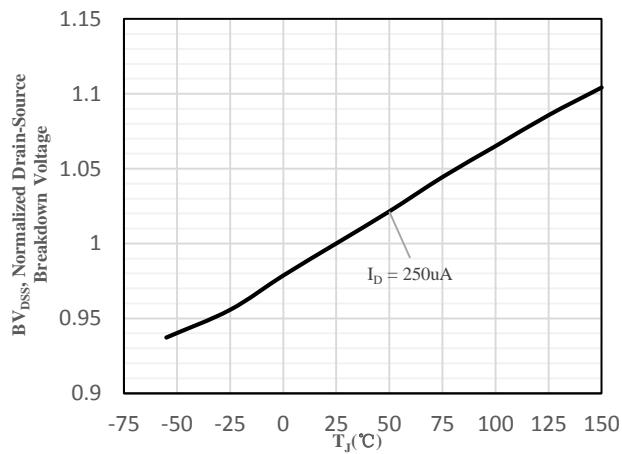


Fig 9 Normalized Breakdown Voltage
vs. Junction Temperature

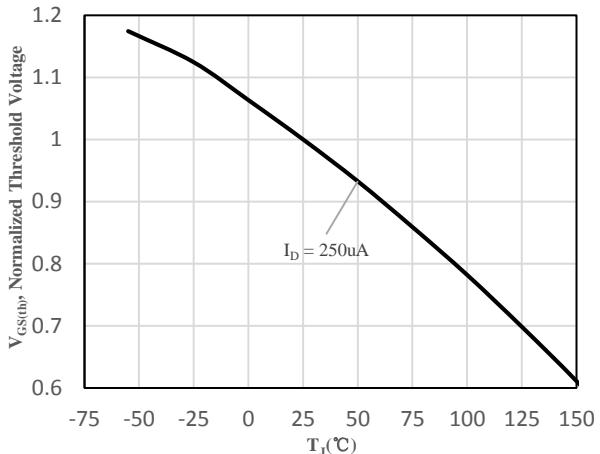
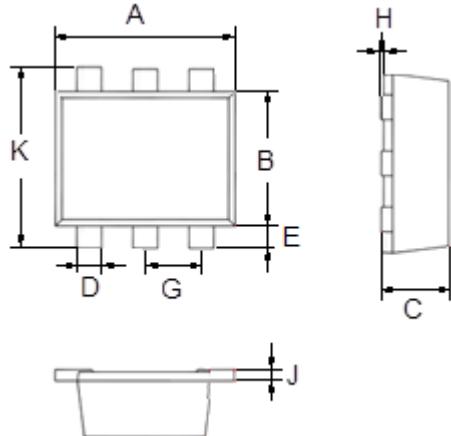


Fig 10 Normalized $V_{GS(th)}$ vs. Junction Temperature

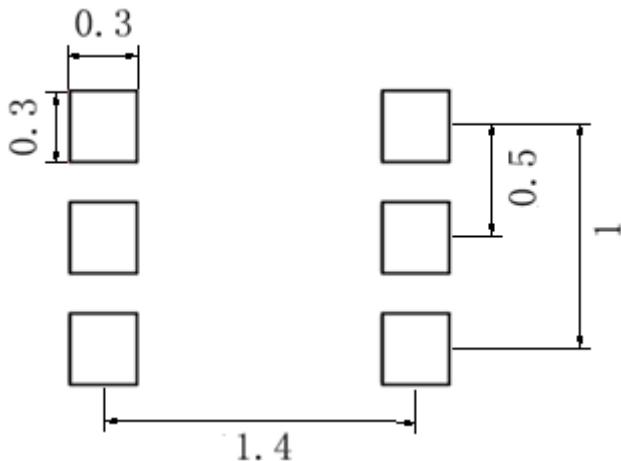
Package Outline Dimensions (Unit: mm)



SOT-563		
Dimension	Min.	Max.
A	1.500	1.700
B	1.100	1.300
C	0.525	0.600
D	0.170	0.270
E	0.100	0.300
G	0.450	0.550
H	0.000	0.050
J	0.090	0.160
K	1.500	1.700

Mounting Pad Layout (Unit: mm)

SOT-563



Important Notice

Changzhou Galaxy Century Microelectronics (GME) reserves the right to make changes without further notice to any product information (copyrighted) herein to make corrections, modifications, improvements, or other changes. GME does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others.